



REV	MODIFICATION	DATE	DRAW
B	EN-07-0801	96.08.01	SAN
C	EN-09-0923	98.09.24	SAN
D	EN-10-0206	99.02.04	SAN

Pin No.	MINI SD
PIN1	DAT1 8P
PIN2	DAT0 7P
PIN3	VSS2 6P
PIN4	CLK 5P
PIN5	VDD 4P
PIN6	NC 11P
PIN7	NC 10P
PIN8	VSS1 3P
PIN9	CMD 2P
PIN10	CD/DAT3 1P
PIN11	DATA2 9P

MATERIALS

HOUSING: LCP (UL 94V-0)
 SHELL: COPPER ALLOY, NICKEL PLATING
 TERMINAL: COPPER ALLOY, GOLD PLATED ON CONTACT AREA
 TIN PLATED ON SOLDER TAIL

SPECIFICATION

CURRENT RATING: 0.5 AMP MAX
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 100m OHMS MAX
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
 OPERATION TEMPERATURE: -25°C~+85°C

ORDER INFORMATION

MDDMF-111 XX B I 00
 01:GOLD FLASH COMPLY TO RoHS
 30:30u" GOLD



P.C.B LAYOUT
 TOP VIEW ±0.05

DIMENSION IN mm [Inch]	PROD. SPEC.	C KINGFONT PRECISION INDUSTRIAL CO., LTD.	
TOLERANCE UNLESS OTHERWISE SPECIFIED	PKG. SPEC.	TITLE MINI SD 2.05	CUSTOMER DRAWING
.X±0.30 X'± 1"	APPROVE <i>Gamy</i>	FILE NO.	DWG NO. MDDMF-111XXBT00
.XX±0.20 .X'± 0.5"	CHECK <i>Tony</i>	SIZE A4	PROJ. SHEET 1 / 1
.XXX±0.10 .XX'± 0.25"	DRAW <i>Sam</i>	SCALE 3:1	REV D